STW23N80K5



N-channel 800 V, 0.23 Ω typ., 16 A MDmesh™ K5 Power MOSFET in a TO-247 package

Datasheet - production data

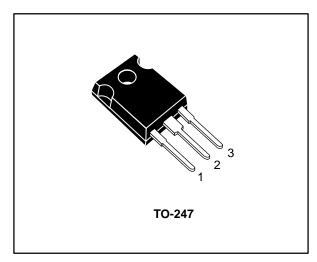
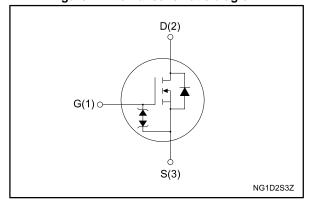


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD	Ртот
STW23N80K5	800 V	0.28 Ω	16 A	190 W

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STW23N80K5	23N80K5	TO-247	Tube

Contents STW23N80K5

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STW23N80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	±30	V
l-	Drain current (continuous) at T _{case} = 25 °C	16	۸
l _D	Drain current (continuous) at T _{case} = 100 °C	10	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	64	Α
P _{TOT}	Total dissipation at T _{case} = 25 °C	190	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	4.5	V/ns
dv/dt ⁽³⁾	v/dt ⁽³⁾ MOSFET dv/dt ruggedness		V/IIS
T _{stg}	Storage temperature	55 to 150	
T _j Operating junction temperature		-55 to 150	°C

Notes:

Table 3: Thermal data

Symbol Parameter		Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.66	٥٥٨٨
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

Table 4: Avalanche characteristics

Symbol	Symbol Parameter		Unit
IAR ⁽¹⁾	Avalanche current, repetitive or not repetitive	5	Α
E _{AS} ⁽²⁾ Single pulse avalanche energy		400	mJ

Notes:

⁽¹⁾ Pulse width is limited by safe operating area.

 $^{^{(2)}}$ $I_{SD} \leq$ 16 A, di/dt=100 A/µs; V_{DS} peak < $V_{(BR)DSS},$ V_{DD} = 80% $V_{(BR)DSS}.$

 $^{^{(3)}}$ V_{DS} ≤ 640 V

 $^{^{\}left(1\right)}$ Pulse width limited by $T_{jmax}.$

 $^{^{(2)}}$ starting T_j = 25 °C, I_D = $I_{AR},\,V_{DD}$ = 50 V.

Electrical characteristics STW23N80K5

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			V
	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	
I _{DSS}		V _{GS} = 0 V, V _{DS} = 800 V, T _{case} = 125 °C			50	μΑ
I_{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 8 A		0.23	0.28	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	1000	•	
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	65	ı	pF
Crss	Reverse transfer capacitance	Ves = 0 V	-	1.5	-	P1
C _{O(tr)} ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	-	165	1	5.F
C _{O(er)} ⁽²⁾	Equivalent output capacitance	V _{DS} = 0 to 640 V, V _{GS} = 0 V	-	59	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	4.7	•	Ω
Q_g	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 16 \text{ A},$	-	33	ı	
Qgs	Gate-source charge	V _{GS} = 10 V (see Figure 14: "Test circuit for gate charge	-	6	-	nC
Q_{gd}	Gate-drain charge	behavior")	-	25	1	

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 400 \text{ V}, I_D = 8 \text{ A}$	-	14	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 13: "Test circuit for	-	9	-	
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	48	-	ns
t _f	Fall time	and Figure 18: "Switching time waveform")	1	9	1	

 $^{^{(1)}}$ Time related is defined as a constant equivalent capacitance giving the same charging time as C_{OSS} when V_{DS} increases from 0 to 80% V_{DSS} .

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDs increases from 0 to 80% VDss

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		16	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		64	Α
V _{SD} ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 16 A	-		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 16 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	410		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	7		μC
I _{RRM}	Reverse recovery current		-	34		Α
t _{rr}	Reverse recovery time	$I_{SD} = 16 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	650		ns
Qrr	Reverse recovery charge	V_{DD} = 60 V, T_j = 150 °C (see Figure 15: "Test circuit for	-	10		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	32		Α

Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

⁽¹⁾ Pulse width is limited by safe operating area.

 $^{^{(2)}}$ Pulse test: pulse duration = 300 μ s, duty cycle 1.5%.

2.1 Electrical characteristics (curves)

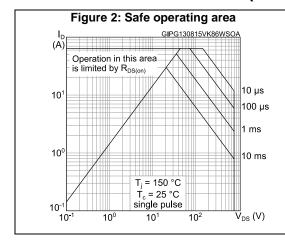
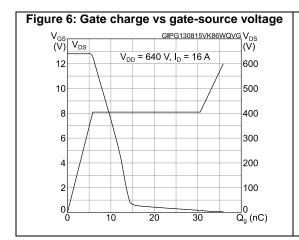
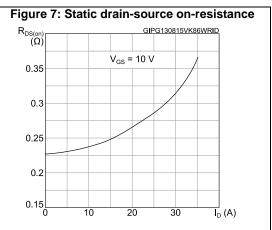


Figure 3: Thermal impedance K

GC20530 $\delta = 0.5$ $\delta = 0.2$ $\delta = 0.1$ $\delta = 0.05$ $\delta = 0.05$ $\delta = 0.01$ Single pulse $\delta = 0.01$ $\delta = 0.01$





STW23N80K5 Electrical characteristics

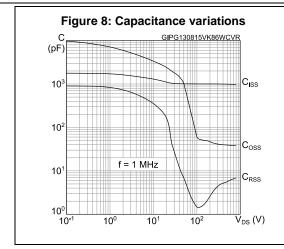


Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG130815VK86WRON (norm.)

2.6

2.2

1.8

1.4

1.0

0.6

0.2

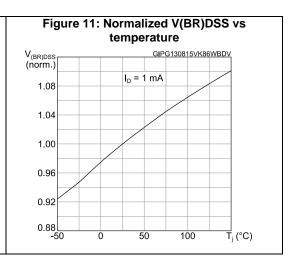
-50

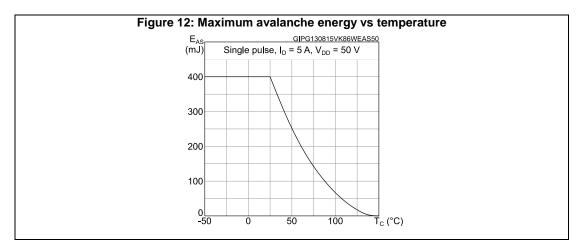
0

50

100

T_j (°C)





Test circuits STW23N80K5

3 Test circuits

Figure 13: Test circuit for resistive load switching times

Figure 14: Test circuit for gate charge behavior

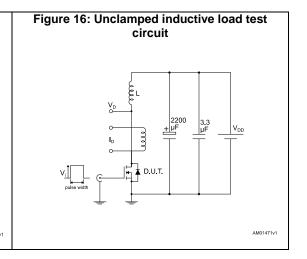
12 V 47 kΩ 100 nF D.U.T.

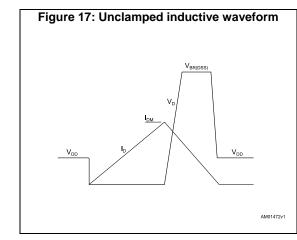
2200 PF 47 kΩ OVG

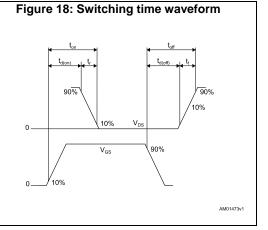
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Figure 15: Test circuit for inductive load switching and diode recovery times

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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-247 package information

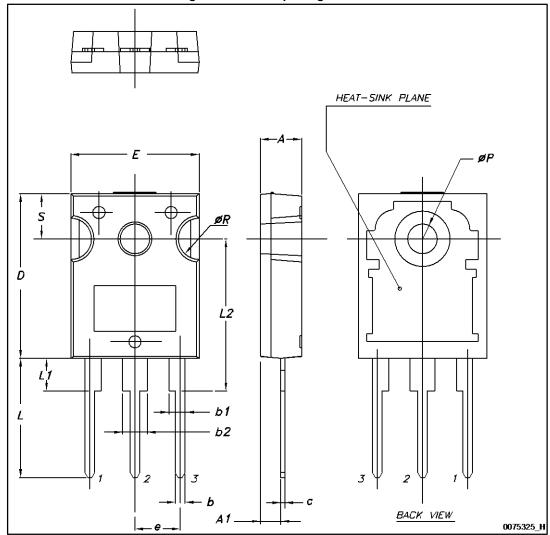


Figure 19: TO-247 package outline

Table 10: TO-247 package mechanical data

Dim	mm.				
Dim.	Min.	Тур.	Max.		
А	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
Е	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		

STW23N80K5 Revision history

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
27-Aug-2015	1	First release.

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